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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/687,048	10/13/2000	Tae Heon Lee	AMKOR-052A	1120
7663 7	590 10/05/2005	EXAMINER		
	RUNDA GARRED &	NGUYEN, DILINH P		
	75 ENTERPRISE, SUITE 250 ALISO VIEJO, CA 92656		ART UNIT	PAPER NUMBER
112100 (1210	,		2814	<u> </u>
			DATE MAILED: 10/05/2005	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
Office Action Summany	09/687,048	LEE ET AL.				
Office Action Summary	Examiner	Art Unit				
	DiLinh Nguyen	2814				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).						
Status						
1) Responsive to communication(s) filed on 7/28/	05.					
/_	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
,—	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims						
4)⊠ Claim(s) <u>16,17,19-26,28-32,34 and 35</u> is/are pending in the application.						
•	4a) Of the above claim(s) is/are withdrawn from consideration.					
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>16,17,19-26,28-32,34 and 35</u> is/are rejected.						
7) Claim(s) is/are objected to.	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,					
8) Claim(s) are subject to restriction and/or	r election requirement.					
,	4					
Application Papers						
9) The specification is objected to by the Examiner.						
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).						
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority under 35 U.S.C. § 119						
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 4) Interview Summary (PTO-413) Paper No(s)/Mail Date 5) Notice of Informal Patent Application (PTO-152) 6) Other:						

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.
- 2. Claims 16-17, 19-23, 25-26, 28-32 and 34-35 are rejected under 35 U.S.C. 102(e) as being anticipated by Minamio et al. (U.S. Pat. 6642609).
 - Regarding claims 16, 25 and 31, Minamio et al. disclose a semiconductor package comprising:
 - a chip paddle 1 (fig. 5) defining opposed top and bottom surfaces and a plurality of sides and corners; and

at least two sets of leads 4 and 5 (fig. 1) extending along respective ones of the sides of the chip paddle in spaced relation thereto, each set of leads including at least two outer leads and at least one inner lead disposed between the outer leads, the inner and outer leads of each set each defining opposed top and bottom surfaces, with at least portion of the bottom surfaces of the outer leads of each set each being of a first length and at least a portion of the bottom surface of the inner lead of each set being of a second length which is unequal to the first length;

a semiconductor chip 12 mounted to the top surface of the chip paddle and electrically connected to at least one of the inner and outer leads; and

an encapsulation material 15 covering the leadframe and the semiconductor chip 12 such that the portions of the bottom surfaces of the inner and outer leads which are of the second length and the first length, respectively, are completely exposed in the encapsulation material (fig. 4, column 5, lines 65 et seq).

- Regarding claims 17, 26 and 32, Minamio et al. disclose multiple sets of leads
 which extend along respective ones of each of the sides of the chip paddle 20 in
 spaced relation thereto (fig. 1).
- Regarding claims 19, 28 and 34, Minamio et al. disclose that the first length of
 the exposed portion of the bottom surface of each of the outer leads 4 exceeds
 the second length of the exposed portion of the bottom surface of the inner lead
 5 (fig. 1).
- Regarding claims 20, 29 and 35, Minamio et al. disclose that the first length of
 the exposed portion of the bottom surface of each of the outer leads 5 is less
 than the second length of the exposed portion of the bottom surface of the inner
 lead 4 (fig. 1).
- Regarding claim 21, Minamio et al. disclose that wherein at least a portion of the bottom surface of the chip paddle 1 is exposed in the encapsulation material 15 (fig. 5).
- Regarding claim 22, Minamio et al. disclose that the encapsulation material
 defines a generally planar bottom surface; the exposed portion of the bottom
 surface of the chip paddle is generally planar and substantially flush with the
 bottom surface of the encapsulation material; and the exposed portions of the

bottom surfaces of the inner and outer leads are each generally planar and substantially flush with the bottom surface of the encapsulation material 15 (figs. 4 and 5).

- Regarding claim 23, Minamio et al. disclose that one tie bar 3 attached to and
 extending from at least one of the corners of the chip paddle, the tie bar defining
 opposed top and bottom surfaces (fig. 1).
- Regarding claim 24, Okumura et al. disclose that the bottom surface of the at least one tie bar 9 is exposed in the encapsulation material 15 (fig. 5a).
- Regarding claim 30, Minamio et al. disclose that the encapsulation material 15
 defines a generally planar bottom surface; and the bottom surfaces of the inner
 and outer leads are each generally planar and substantially flush with the bottom
 surface of the encapsulation material (fig. 5).

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claim 24 is rejected under 35 U.S.C. 103(a) as being unpatentable over Minamio et al. (U.S. Pat. 6642609) in view of Okumura et al. by (U.S. Pat. 5942794).

Minamio et al. substantially disclose all the limitations as claimed above except for at least a portion of the bottom surface of the at least one tie bar is exposed in the encapsulation material.

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However, Okumura et al. disclose a semiconductor package comprising a leadframe having at least one tie bar 9 attached to and extending from at least one of the corners of the chip paddle 20, the tie bar 9 defining opposed top and bottom surfaces; wherein at least a portion of the bottom surface of the at least one tie bar is exposed in the encapsulation material 15 (figs. 5a-5b). Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the device structure of Minamio et al. by having at least a portion of the bottom surface of the at least one tie bar is exposed, as taught by Okumura et al., in order to increase a packaging density in mounting semiconductor devices on a mother board (abstract).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DiLinh Nguyen whose telephone number is (571) 272-1712. The examiner can normally be reached on 8:00AM - 6:00PM (M-F).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

DLN

HOAI PHAM
PRIMARY EXAMINER